

### General Description

The 70N03 is the highest performance trench N-ch MOSFETs with extreme high cell density ,which provide excellent RDSON and gate charge for most of the synchronous buck converter applications . The 70N03 meet the RoHS requirement , 100% EAS guaranteed with full function reliability approved.

### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- 100% avalanche tested
- RoHS Compliant

### Absolute Maximum Ratings

| Symbol                | Parameter                                  | Rating     | Units      |
|-----------------------|--------------------------------------------|------------|------------|
| $V_{DS}$              | Drain-Source Voltage                       | 30         | V          |
| $V_{GS}$              | Gate-Source Voltage                        | $\pm 20$   | V          |
| $I_D@T_C=25^\circ C$  | Continuous Drain Current                   | 70         | A          |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current                   | 50         | A          |
| $I_{DM}$              | Pulsed Drain Current <sup>1</sup>          | 170        | A          |
| EAS                   | Single Pulse Avalanche Energy <sup>2</sup> | 85         | mJ         |
| $P_D@T_C=25^\circ C$  | Total Power Dissipation                    | 65         | W          |
| $T_{STG}$             | Storage Temperature Range                  | -55 to 175 | $^\circ C$ |
| $T_J$                 | Operating Junction Temperature Range       | -55 to 175 | $^\circ C$ |

### Thermal Data

| Symbol          | Parameter                           | Typ. | Max. | Unit         |
|-----------------|-------------------------------------|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient | ---  | 70   | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction -Case   | ---  | 2    | $^\circ C/W$ |

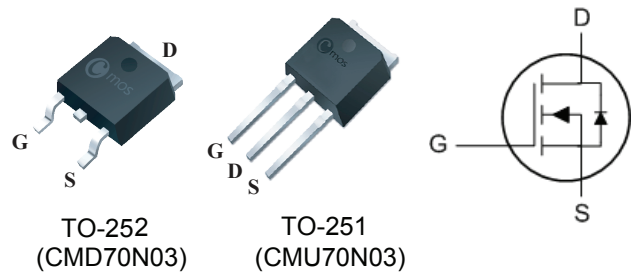
### Product Summary

| BVDSS | RDSON       | ID  |
|-------|-------------|-----|
| 30V   | 7m $\Omega$ | 70A |

### Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

### TO-252/251 Pin Configuration



**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

| Symbol              | Parameter                                      | Conditions                                                                              | Min. | Typ. | Max. | Unit |
|---------------------|------------------------------------------------|-----------------------------------------------------------------------------------------|------|------|------|------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                                              | 30   | ---  | ---  | V    |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance <sup>1</sup> | V <sub>GS</sub> =10V, I <sub>D</sub> =28A                                               | ---  | 4    | 7    | mΩ   |
|                     |                                                | V <sub>GS</sub> =4.5V, I <sub>D</sub> =25A                                              | ---  | 7.5  | 11.5 |      |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                         | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                | 1    | 1.7  | 3    | V    |
| I <sub>DSS</sub>    | Drain-Source Leakage Current                   | V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C                         | ---  | ---  | 1    | uA   |
|                     |                                                | V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C                        | ---  | ---  | 10   |      |
| I <sub>GSS</sub>    | Gate-Source Leakage Current                    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                              | ---  | ---  | ±100 | nA   |
| g <sub>fs</sub>     | Forward Transconductance                       | V <sub>DS</sub> =10V, I <sub>D</sub> =28A                                               | ---  | 30   | ---  | S    |
| R <sub>g</sub>      | Gate Resistance                                | V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz                                        | ---  | 1.7  | 3.4  | Ω    |
| Q <sub>g</sub>      | Total Gate Charge                              | V <sub>DS</sub> =15V, V <sub>GS</sub> =5V, I <sub>D</sub> =30A                          | ---  | 15   | ---  | nC   |
| Q <sub>gs</sub>     | Gate-Source Charge                             |                                                                                         | ---  | 8.1  | ---  |      |
| Q <sub>gd</sub>     | Gate-Drain Charge                              |                                                                                         | ---  | 4.7  | ---  |      |
| T <sub>d(on)</sub>  | Turn-On Delay Time                             | V <sub>DD</sub> =15V, V <sub>GS</sub> =10V, R <sub>G</sub> =3.3Ω<br>I <sub>D</sub> =30A | ---  | 13   | ---  | ns   |
| T <sub>r</sub>      | Rise Time                                      |                                                                                         | ---  | 6.7  | ---  |      |
| T <sub>d(off)</sub> | Turn-Off Delay Time                            |                                                                                         | ---  | 22.5 | ---  |      |
| T <sub>f</sub>      | Fall Time                                      |                                                                                         | ---  | 10.1 | ---  |      |
| C <sub>iss</sub>    | Input Capacitance                              | V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, f=1MHz                                       | ---  | 3200 | ---  | pF   |
| C <sub>oss</sub>    | Output Capacitance                             |                                                                                         | ---  | 510  | ---  |      |
| C <sub>rss</sub>    | Reverse Transfer Capacitance                   |                                                                                         | ---  | 180  | ---  |      |

**Diode Characteristics**

| Symbol          | Parameter                          | Conditions                                                     | Min. | Typ. | Max. | Unit |
|-----------------|------------------------------------|----------------------------------------------------------------|------|------|------|------|
| I <sub>S</sub>  | Continuous Source Current          | V <sub>G</sub> =V <sub>D</sub> =0V, Force Current              | ---  | ---  | 70   | A    |
| I <sub>SM</sub> | Pulsed Source Current <sup>1</sup> |                                                                | ---  | ---  | 170  | A    |
| V <sub>SD</sub> | Diode Forward Voltage <sup>1</sup> | V <sub>GS</sub> =0V, I <sub>S</sub> =10A, T <sub>J</sub> =25°C | ---  | ---  | 1.3  | V    |

Note :

- 1.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 2.The test condition is V<sub>DD</sub>=30V,V<sub>GS</sub>=10V,L=0.1mH,I<sub>L</sub>=12A

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